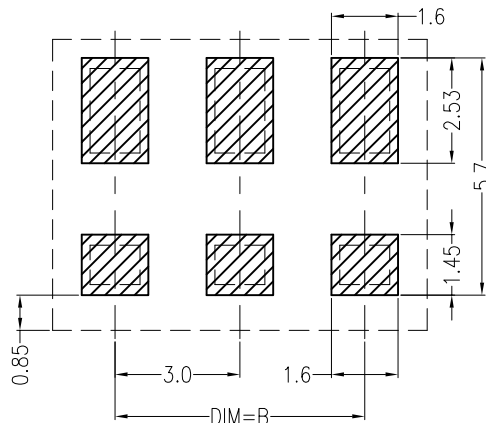
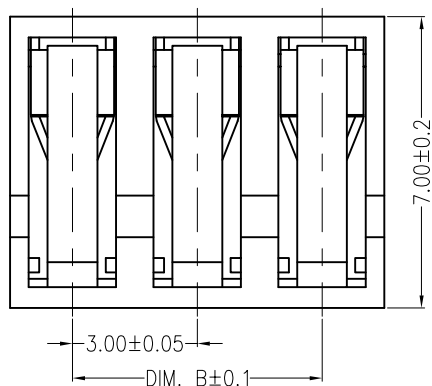
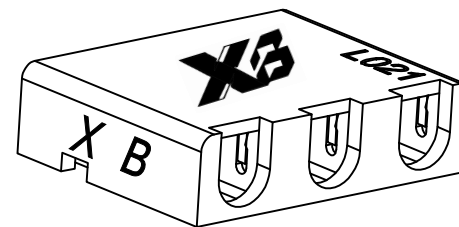
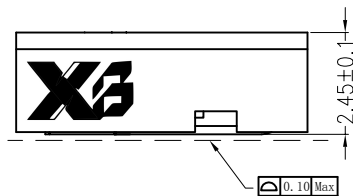
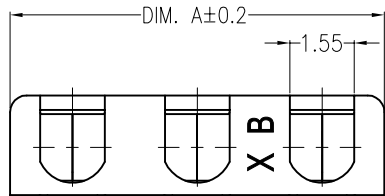




Board Layout

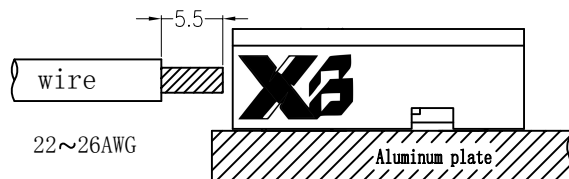
主要技术参数 Main Specifications

线数 (Poles): 01 to 03
接触电阻 (Contact resistance): $\leq 20\text{m}\Omega$
绝缘电阻 (Insulation resistance): $\geq 800\text{M}\Omega$
额定电压 (Rated voltage): 250 V AC DC
额定电流 (Rated current): 2.0A AC DC
耐电压 (Withstand Voltage): 1500V AC/minute
温度范围 (Temperature Range): $-40^{\circ}\text{C} \sim +110^{\circ}\text{C}$

ORDER INFORMATION:

XB-L021-**-D1CB-R

PART No. _____
No. FOR CIRCUITS: _____
01-03
PLASTIC MATERIAL: _____
D1C=PA9T (BEIGE)
PACKAGING: _____
R=REEL
P=PE
PLATING: _____
B=MATTE Sn



Assembly Layout

名称	尺寸	DIM. A	DIM. B	备注
L021-01		3.00		
L021-02		6.00	3.00	
L021-03		9.00	6.00	

C					
B	CONTACT		1~3 PCS	PhosphorBronze	MATTE Sn-plated
A	PEDESTAL		1 PCS	PA9T	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT		Q'TY	MATERIAL	FINISH
东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD					
X.±0.5	X.±5°	USE: CUSTOMER		PART NO.: L021-**-D1CB-R	
.X±0.3	.X±2°	APPD: 邵敬和		DWG NO.: GCCP-0040	
.XX±0.25	.XX±1°	CHKD: 田峰		SCALE 1 : 1	
--	--	DR: 蒋建银		SHEET 1 / 1	
⊕	⊖	UNITS: mm			